(✓) Preliminary Specifications
( ) Final Specifications

Module	**15.6"FHD 16:9 Color TFT-LCD with LED Backlight design**
Model Name	B156HAN01.1 (H/W: 0A)
Note ( )	***LED Backlight with driving circuit design***

Customer **Date**	**Approved by** **Date**
Checked & Approved by **Date**	**Prepared by** **Date** Tina GT Lin 12/25/2012
Note: This Specification is subject to change without notice.	**DMPBU Marketing Division** **AU Optronics corporation**

Contents

Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.1 2012/10/17	All	First Edition for Customer		

1. Handling Precautions

1) Since front polarizer is easily damaged, pay attention not to scratch it.
2) Be sure to turn off power supply when inserting or disconnecting from input connector.
3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
7) Do not open nor modify the Module Assembly.
8) Do not press the reflector sheet at the back of the module to any directions.
9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.

2. General Description

B156HAN01.1 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 FHD, 1920(H) x1080(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are eDP interface compatible.

B156HAN01.1 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 ℃ condition:

Items	Unit	Specifications			
Screen Diagonal	[mm]	394.9			
Active Area	[mm]	344.16 x 193.59			
Pixels H x V		1920 x 3(RGB) x 1080			
Pixel Pitch	[mm]	0.17925 x 0.17925			
Pixel Format		R.G.B. Vertical Stripe			
Display Mode		Normally Black			
White Luminance **(I_{LED} = 20mA)** **(Note: ILED is LED current)**	[cd/m^2]	300 typ. (5 points average) 255 min. (5 points average)			
Luminance Uniformity		1.25 max. (5 points)			
Contrast Ratio		700 typ			
Response Time	[ms]	25 typ			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.			
Power Consumption	[Watt]	5.6 (Include Logic and Blu power)			
Weight	[Grams]	380 max.			
Physical Size **Include bracket**	[mm]		Min.	Typ.	Max.
		Length	359.0	359.5	360.0
		Width	223.3	223.8	224.3
		Thickness	---	---	3.2
Electrical Interface		2 lane eDP			
Glass Thickness	[mm]	0.3			
Surface Treatment		Anti-Glare			
Support Color		262K colors (RGB 6-bit)			
Temperature Range Operating Storage (Non-Operating)	 [°C] [°C]	 0 to +50 -20 to +60			
RoHS Compliance		RoHS Compliance			

Note: Contrast ratio measured in the center of screen

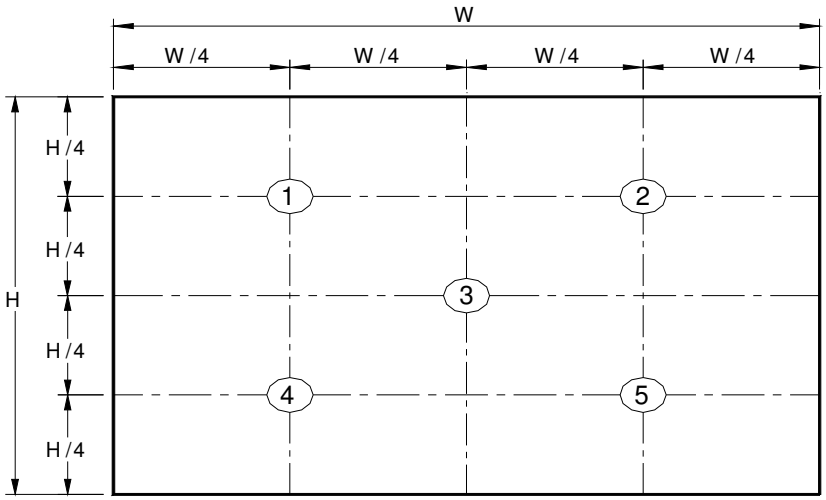
2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25℃ (Room Temperature) :

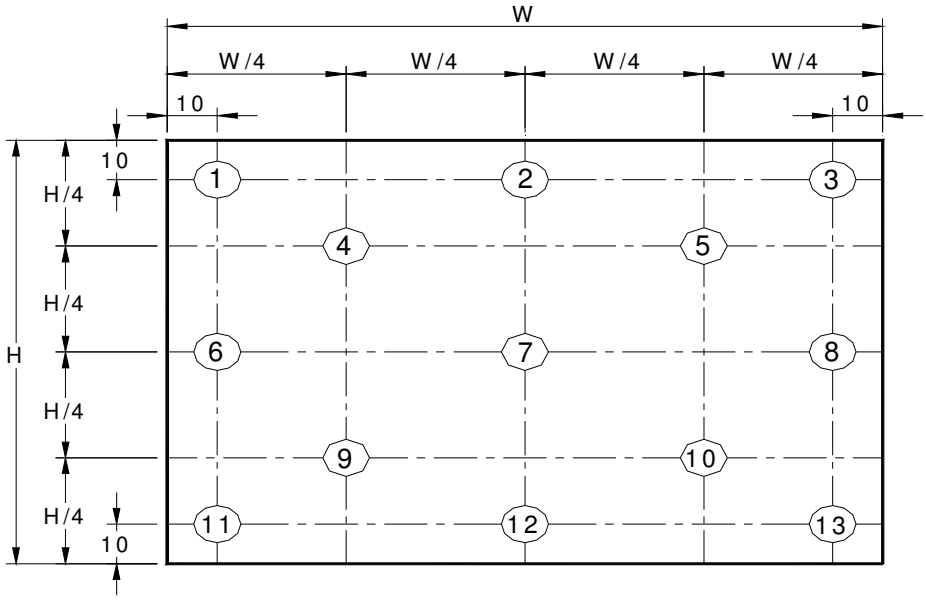
Item		Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
White Luminance ILED=20mA			5 points average	255	300	---	cd/m²	1, 4, 5.
Viewing Angle		θ_R θ_L	Horizontal (Right) CR = 10 (Left)	80 80	85 85	--- ---	degree	4, 9
		ψ_H ψ_L	Vertical (Upper) CR = 10 (Lower)	80 80	85 85	--- ---		
Luminance Uniformity		δ_{5P}	5 Points	---	---	1.25		1, 3, 4
Luminance Uniformity		δ_{13P}	13 Points	---	---	1.60		2, 3, 4
Contrast Ratio		CR			700	-		4, 6
Cross talk		%		---	---	4		4, 7
Response Time		T_{RT}	Rising + Falling	---	25	---	msec	4, 8
Color / Chromaticity Coordinates	Red	Rx	CIE 1931	TBD	TBD	TBD		4
		Ry		TBD	TBD	TBD		
	Green	Gx		TBD	TBD	TBD		
		Gy		TBD	TBD	TBD		
	Blue	Bx		TBD	TBD	TBD		
		By		TBD	TBD	TBD		
	White	Wx		0.283	0.313	0.343		
		Wy		0.299	0.329	0.359		
NTSC		%		-	72	-		

Note: Contrast ratio measured in the center of screen

Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



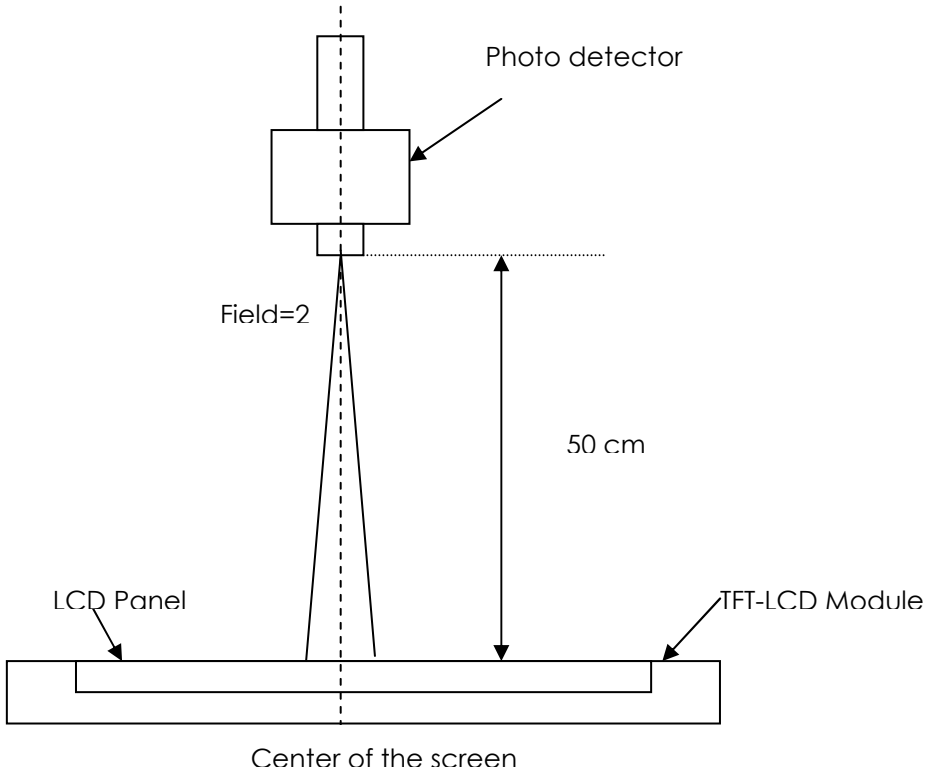
Note 3: The luminance uniformity of 5 or13 points is defined by dividing the maximum luminance values by the minimum test point luminance

$$\delta_{W5} = \frac{\text{Maximum Brightness of five points}}{\text{Minimum Brightness of five points}}$$

$$\delta_{W13} = \frac{\text{Maximum Brightness of thirteen points}}{\text{Minimum Brightness of thirteen points}}$$

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5： Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points，Y_L = [L (1)+ L (2)+ L (3)+ L (4)+ L (5)] / 5

L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6： Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Briahtness on the "White" state}}{\text{Briahtness on the "Black" state}}$$

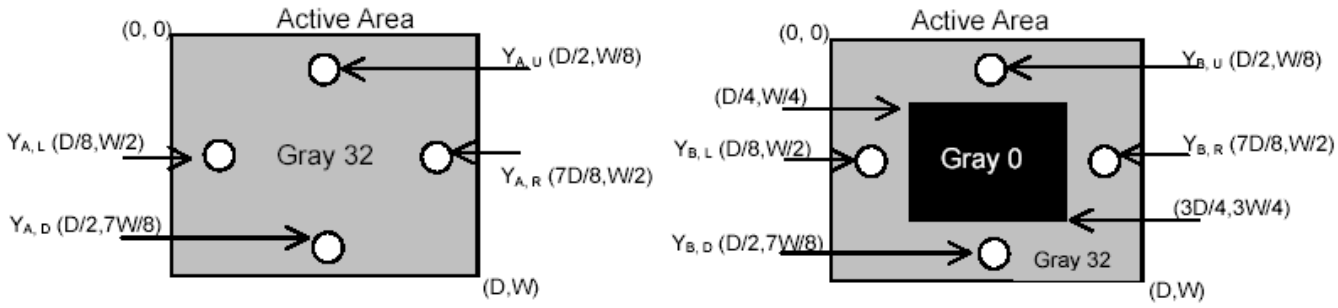
Note 7： Definition of Cross Talk (CT)

$CT = | Y_B - Y_A | / Y_A \times 100$ (%)

Where

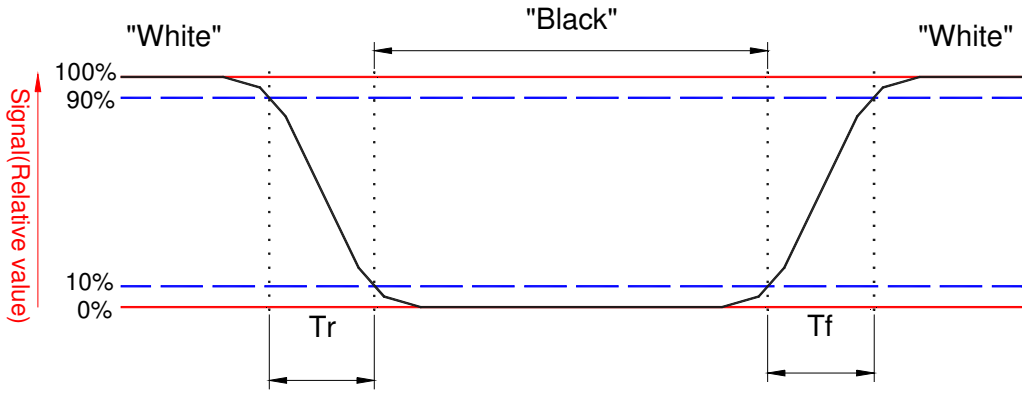
Y_A = Luminance of measured location without gray level 0 pattern (cd/m2)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m2)



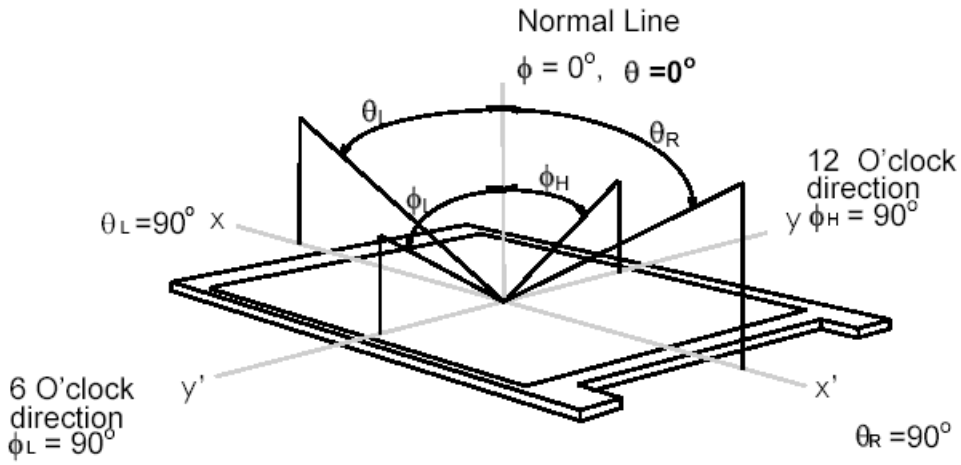
Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.



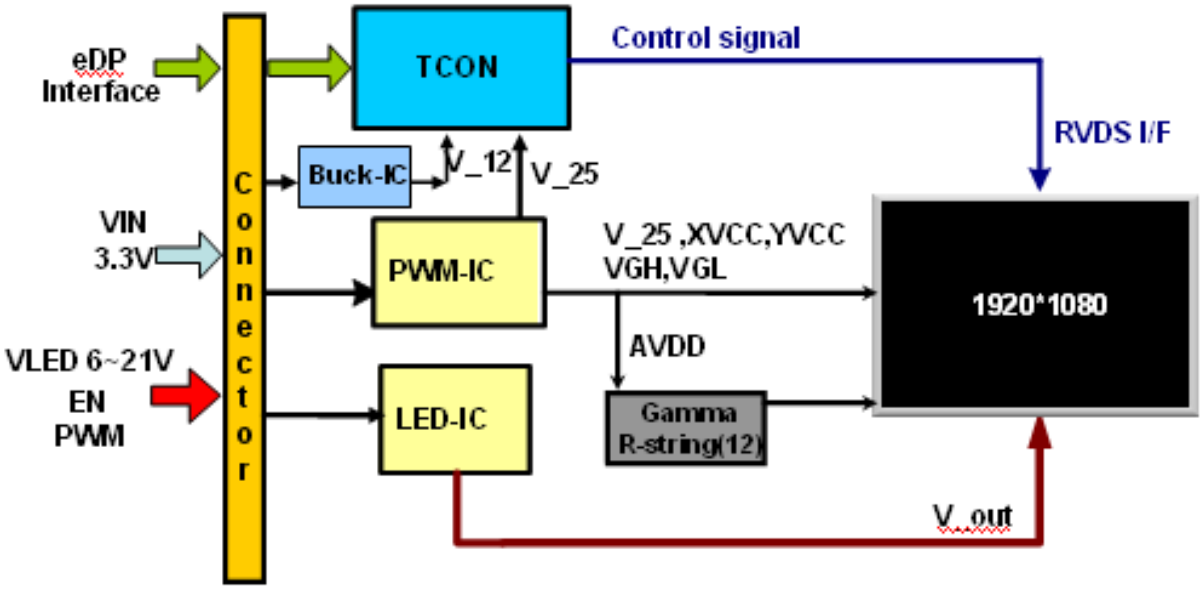
Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio ≧10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



3. Functional Block Diagram

The following diagram shows the functional block of the 15.6 inches wide Color TFT/LCD 30 Pin one channel Module



4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

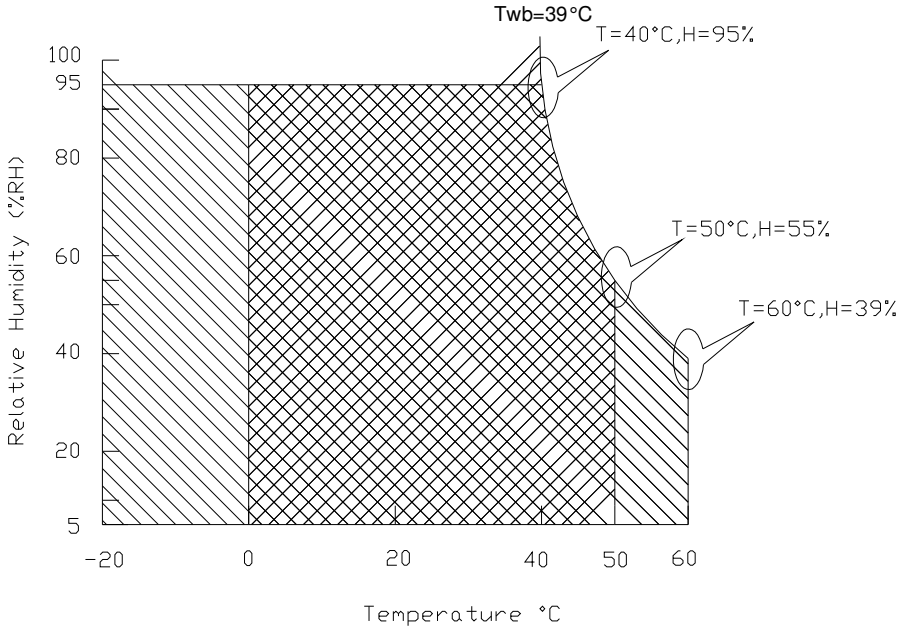
Item	Symbol	Min	Max	Unit	Conditions
Operating	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25℃)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range Storage Range +

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows;

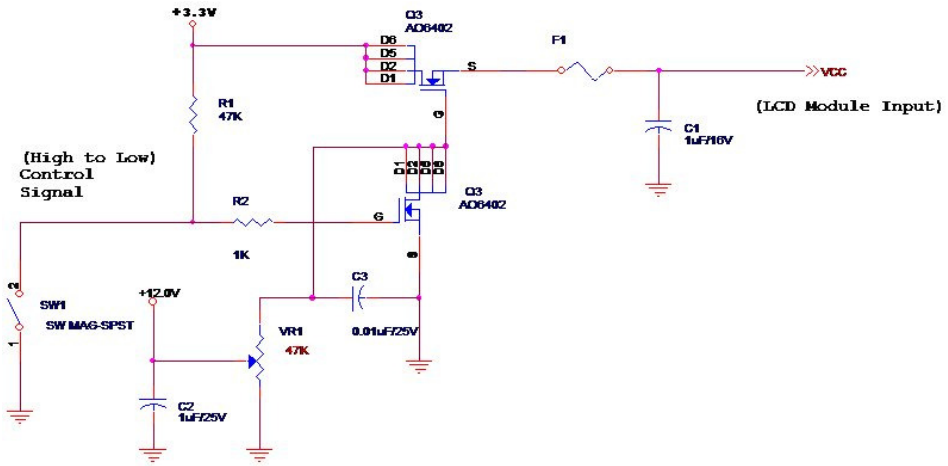
The power specification are measured under 25℃ and frame frenquency under 60Hz

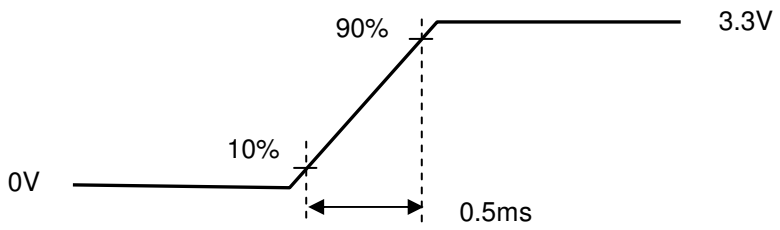
Symble	Parameter	Min	Typ	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	_	-	1.3	[Watt]	Note 1/2
IDD	IDD Current	_	_	433	[mA]	Note 1/2
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : Black Pattern at 3.3V driving voltage. ($P_{max}=V_{3.3} \times I_{black}$)

Typical Measurement Condition : Mosaic Pattern

Note 2 : Measure Condition





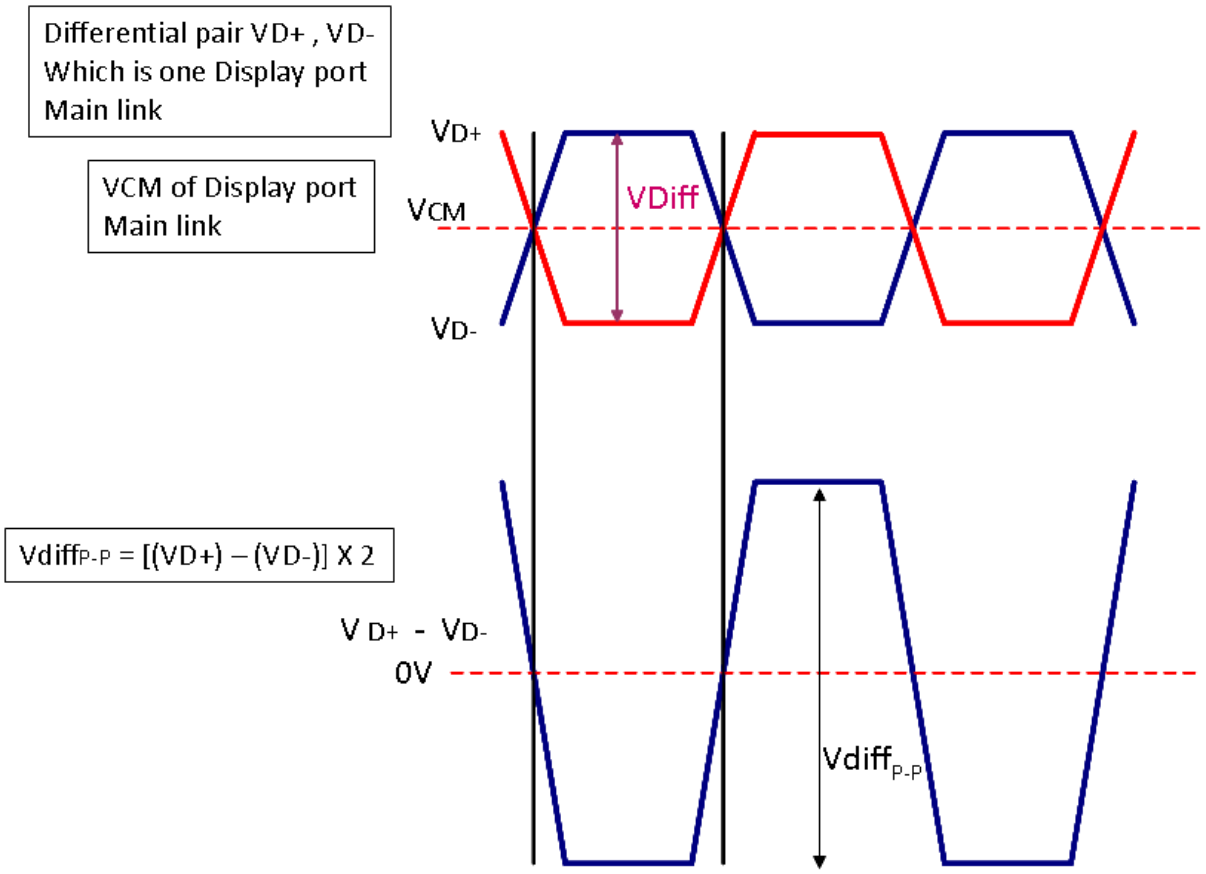
Vin rising time

5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

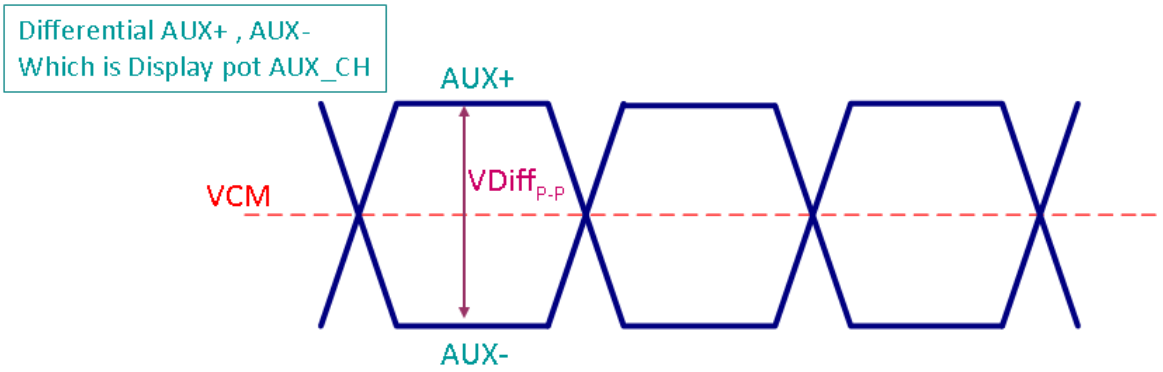
Display Port main link signal:



Display port main link					
		Min	Typ	Max	unit
VCM	RX input DC Common Mode Voltage		0		V
$VDiff_{P-P}$	Peak-to-peak Voltage at a receiving Device	100		1320	mV

Follow as VESA display port standard V1.1a.

Display Port AUX_CH signal:



Display port AUX_CH					
		Min	Typ	Max	unit
VCM	AUX DC Common Mode Voltage		0		V
VDiff$_{P-P}$	AUX Peak-to-peak Voltage at a receiving Device	0.4	0.6	0.8	V

Follow as VESA display port standard V1.1a.

Display Port VHPD signal:

Display port VHPD					
		Min	Typ	Max	unit
VHPD	HPD Voltage	2.25		3.6	V

Fallow as VESA display port standard V1.1a

5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol	Min	Typ	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	4.3	[Watt]	(Ta=25℃), Note 1 Vin =12V
LED Life-Time	N/A	15,000	-	-	Hour	(Ta=25℃), Note 2 I_F=20mA

Note 1: Calculator value for reference P_{LED} = V_F (Normal Distribution) * I_F (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

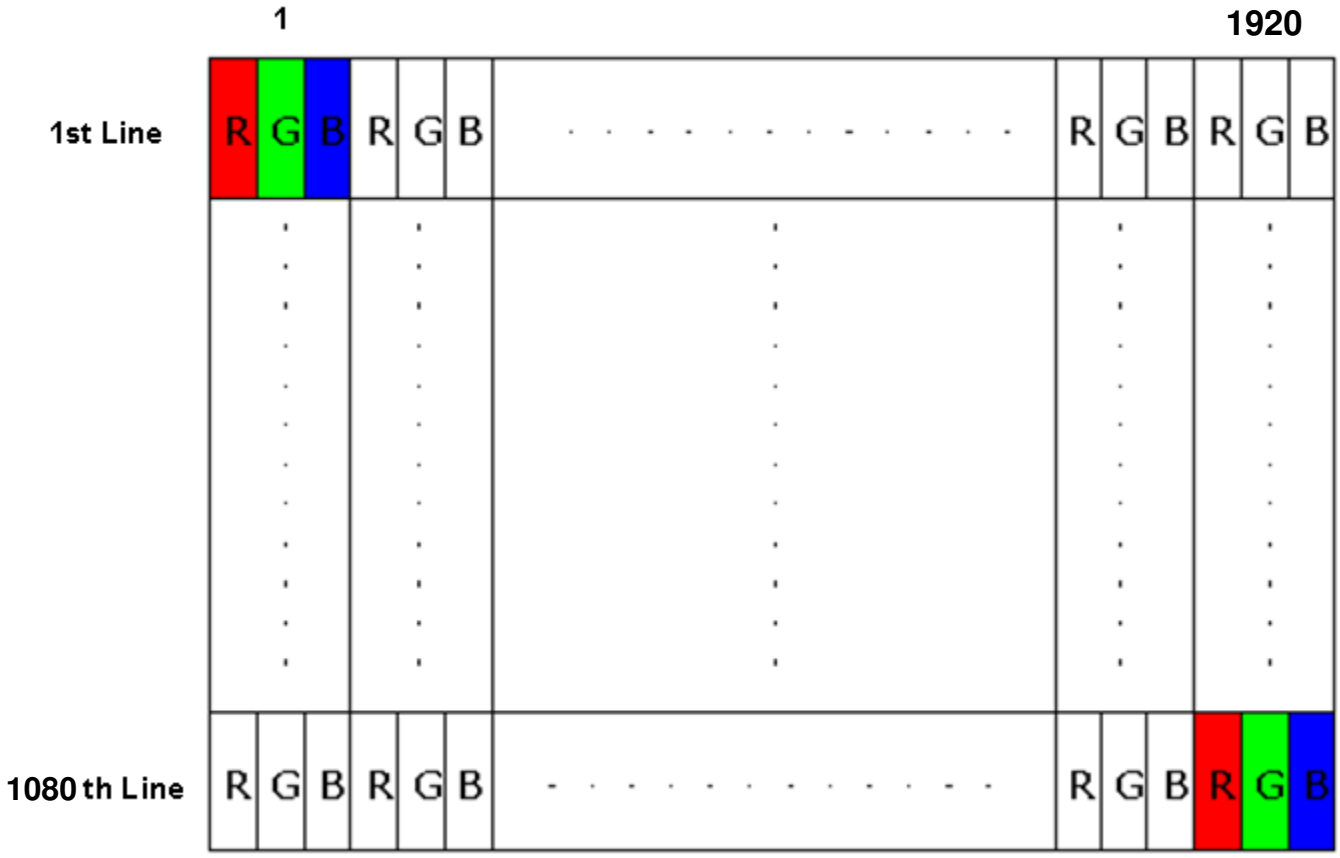
5.3.2 Backlight input signal characteristics

Parameter	Symbol	Min	Typ	Max	Units	Remark
LED Power Supply	VLED	6.0	12.0	21.0	[Volt]	Define as Connector Interface (Ta=25℃)
PWM Logic Input High Level	VPWM_EN	2.5	-	5.5	[Volt]	
PWM Logic Input Low Level		-	-	0.5	[Volt]	
PWM Input Frequency	FPWM	200	1K	10K	Hz	
PWM Duty Ratio	Duty	5	--	100	%	

6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.



6.2 Integration Interface Requirement

6.2.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

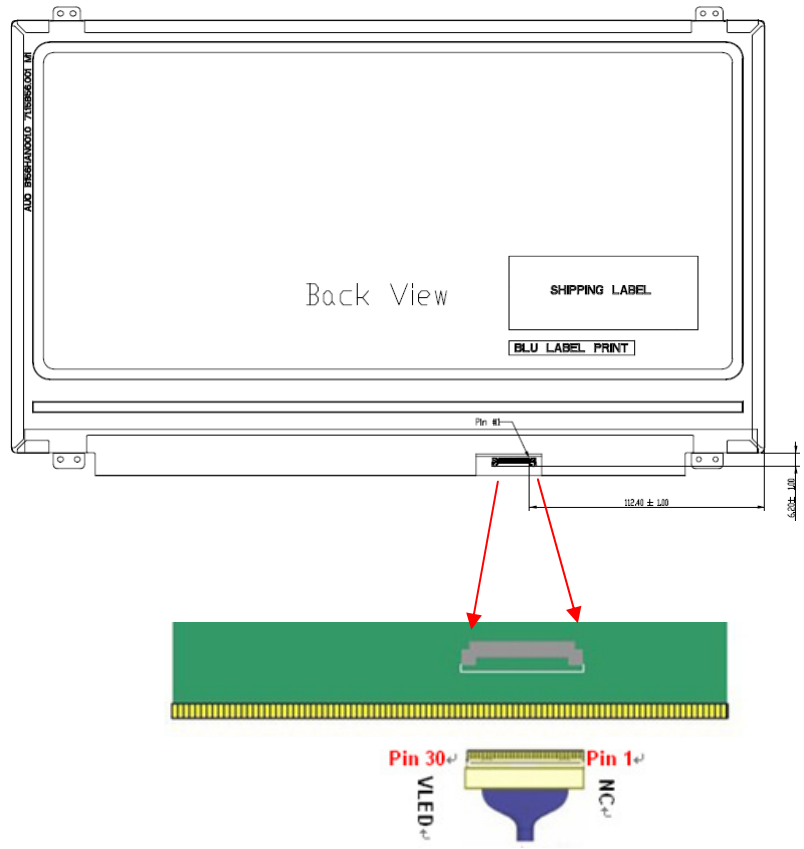
Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or Compatible
Type / Part Number	I-PEX 20455-030E-12 or Compatible
Mating Housing/Part Number	I-PEX 20453-030T or Compatible

6.2.2 Pin Assignment

eDP lane is a differential signal technology for LCD interface and high speed data transfer device.

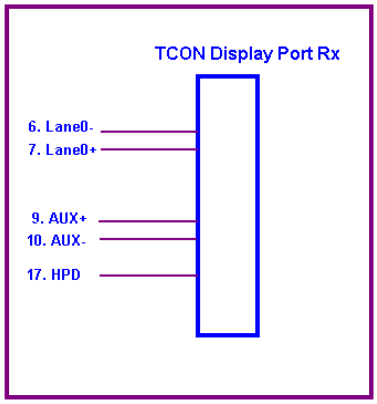
PIN#	Signal Name	Description
1	NC	No connection (Reserved for supplier)
2	GND	Ground
3	Lane1_N	Complement signal link lane1
4	Lane1_P	True signal link lane1
5	GND	Ground
6	Lane0_N	Complement signal link lane0
7	Lane0_P	True signal link lane0
8	GND	Ground
9	AUX_CH_P	True signal Auxiliary Channel
10	AUX_CH_N	Complement signal Auxiliary Channel
11	GND	Ground
12	LCD_VCC	Logic power
13	LCD_VCC	Logic power
14	LCD_Self_Test	LCD Panel Self Test Enable
15	GND	Ground
16	GND	Ground
17	HPD_IN	HPD Signal in
18	LED_GND	Ground
19	LED_GND	Ground
20	LED_GND	Ground
21	LED_GND	Ground

22	BL_Enable	LED Enable
23	BL_PWM	LED PWM
24	NC	AUO fab use
25	NC	AUO fab use
26	V_LED	LED Anode
27	V_LED	LED Anode
28	V_LED	LED Anode
29	V_LED	LED Anode
30	NC	No connection (Reserved for supplier)



Note1：start from right side
Note2：Input signals shall be low or High-impedance state when VDD is off,

internal circuit of eDP inputs are as following.



6.3 Interface Timing

6.3.1 Timing Characteristics

Basically, interface timings should match the 1920x1080 /60Hz manufacturing guide line timing.

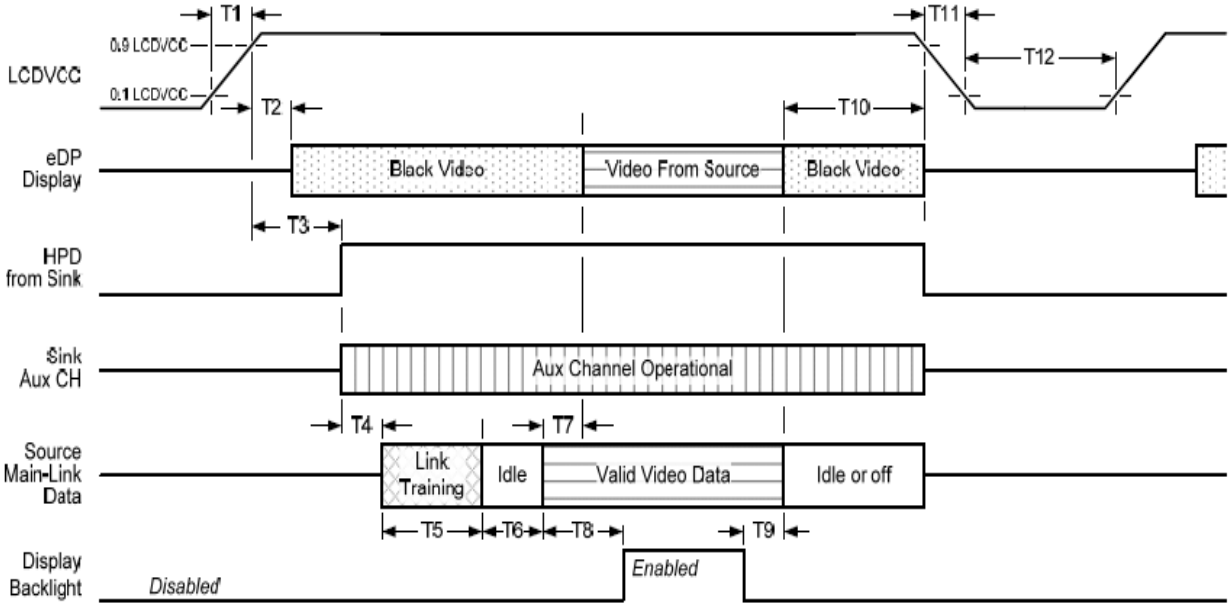
Parameter		Symbol	Min.	Typ.	Max.	Unit
Frame Rate		-	-	60	-	Hz
Clock frequency		1/ T_{Clock}		141		MHz
Vertical Section	Period	T_V	1084	1116	3080	T_{Line}
	Active	T_{VD}		1080		
	Blanking	T_{VB}	4	36	2000	
Horizontal Section	Period	T_H	2000	2104	2320	T_{Clock}
	Active	T_{HD}		1920		
	Blanking	T_{HB}	80	184	400	

Note 1 : The above is as optimized setting
Note 2 : The maximum clock frequency = (1920+B)*(1080+A)*60<149.1MHz
Note 3 : Clock frequency number is for reference, real setting value refer to EDID

6.4 Power On Sequence

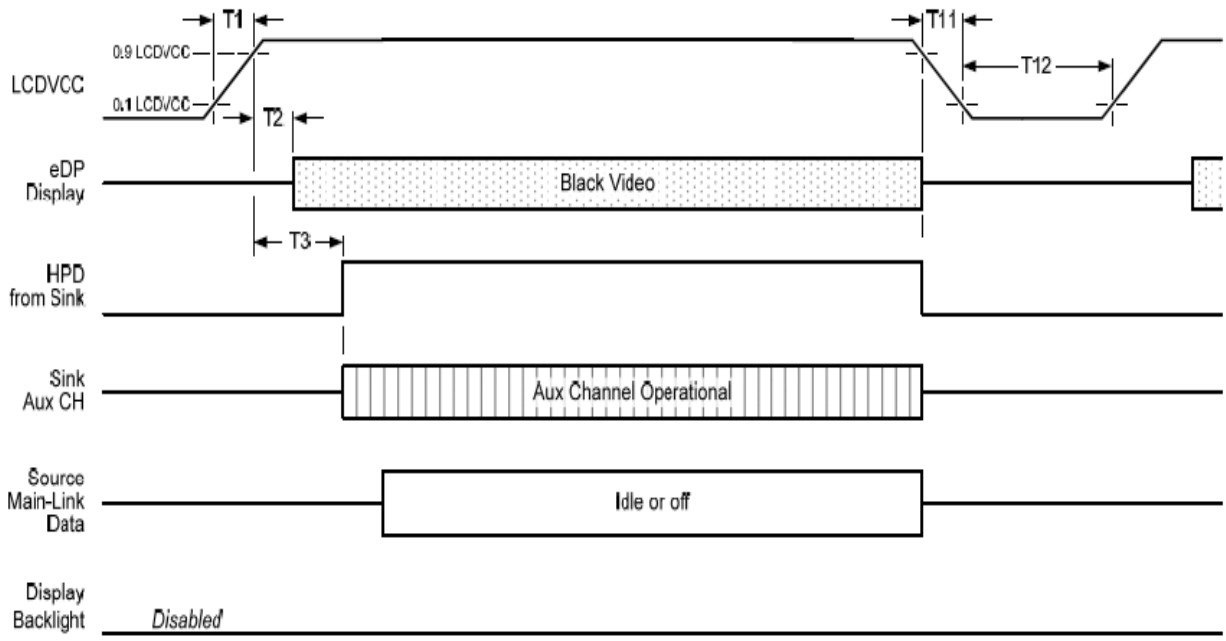
Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart.

Display Port panel power sequence:



Display port interface power up/down sequence, normal system operation

Display Port AUX_CH transaction only:



Display port interface power up/down sequence, AUX_CH transaction only

Display Port panel power sequence timing parameter:

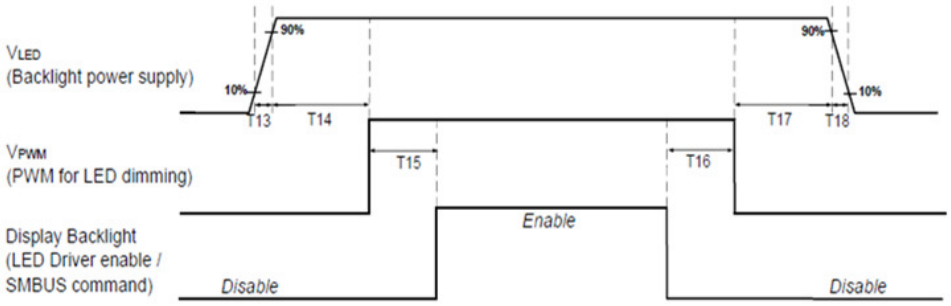
Timing parameter	Description	Reqd. by	Limits			Notes
			Min.	Typ.	Max.	
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms	
T2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source
T3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.
T4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.
T5	link training duration	source				dependant on source link to read training protocol.
T6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.
T7	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.
T8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.
T9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.
T10	delay from end of valid video data from source to power off	source	0ms		500ms	
T11	power rail fall time, 905 to 10%	source			10ms	
T12	power off time	source	500ms			

Note 1: The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:
-upon LCDVDD power on (with in T2 max)-when the "Novideostream_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).
-when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

Note 2: The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

Note 3: The sink must support AUX_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX_CH transaction with the time specified within T3 max.

Display Port panel B/L power sequence timing parameter:

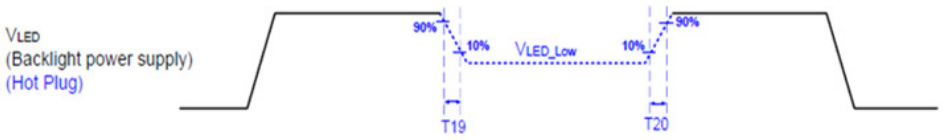


	Min (ms)	Max (ms)
T13	0.5	10
T14	10	-
T15	10	-
T16	10	-
T17	10	-
T18	0.5	10
T19	1*	-
T20	1*	-

Seamless change: T19/T20 = 5xT_{PWM}*

*T_{PWM}= 1/PWM Frequency

Note : When the adapter is hot plugged, the backlight power supply sequence is shown as below.



7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 1.5 G
- Frequency: 10 - 500Hz Random
- Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 220 G , Half sine wave
- Active time: 2 ms
- Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note1: According to EN 61000-4-2 , ESD class B: Some performance degradation allowed. Self-recoverable.

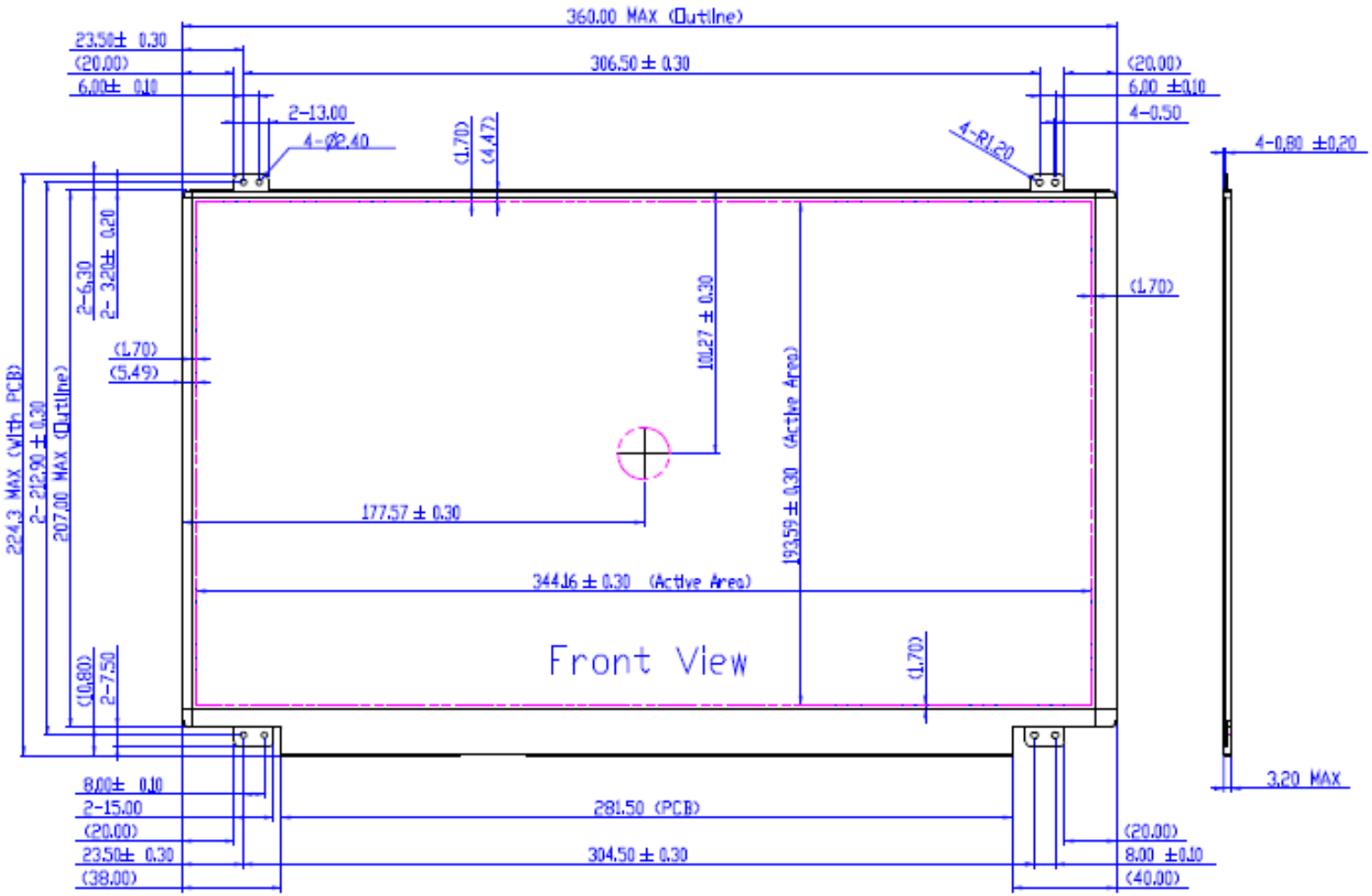
No data lost, No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

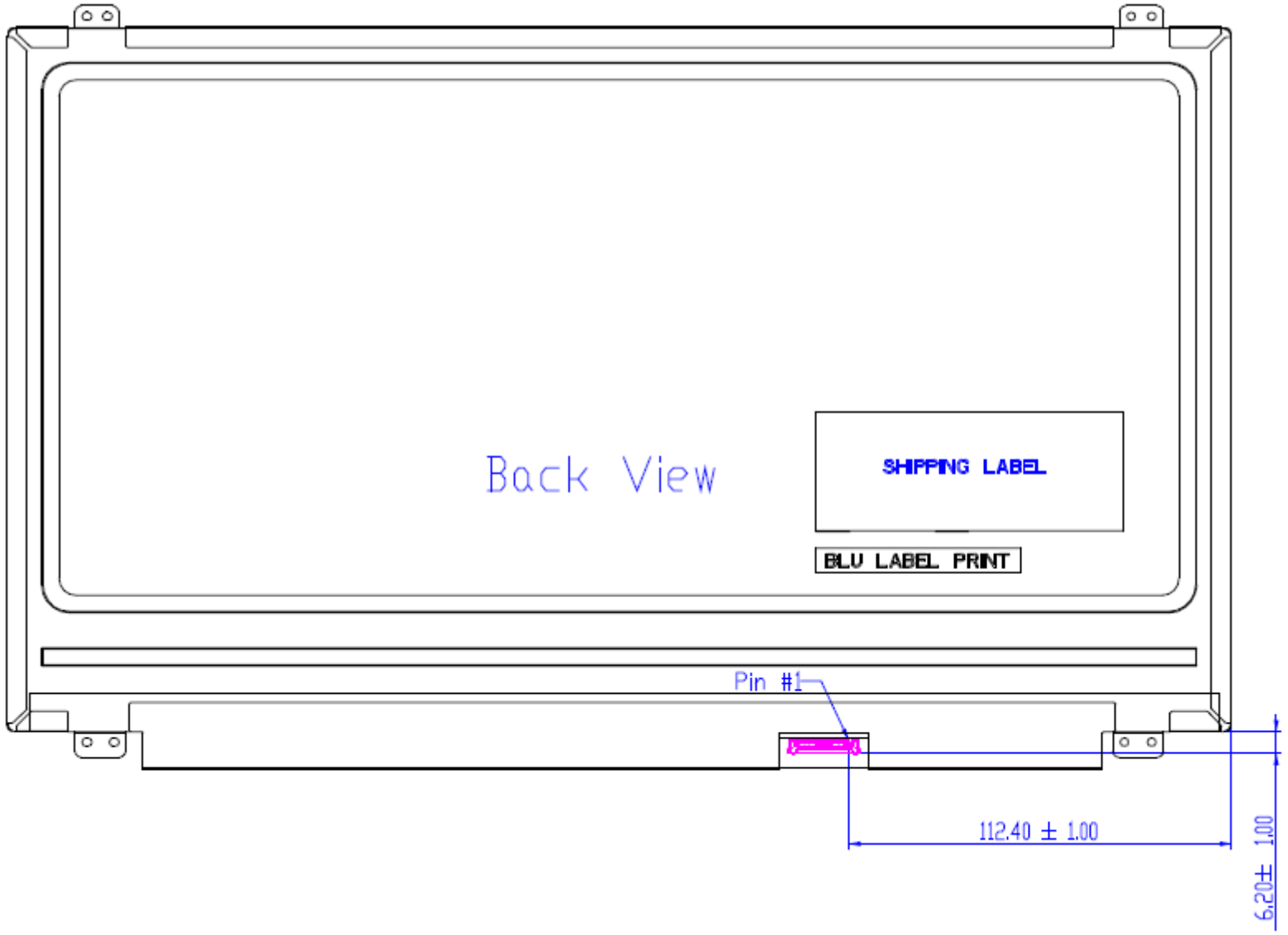
8. Mechanical Characteristics

8.1 LCM Outline Dimension

8.1.1 Standard Front View



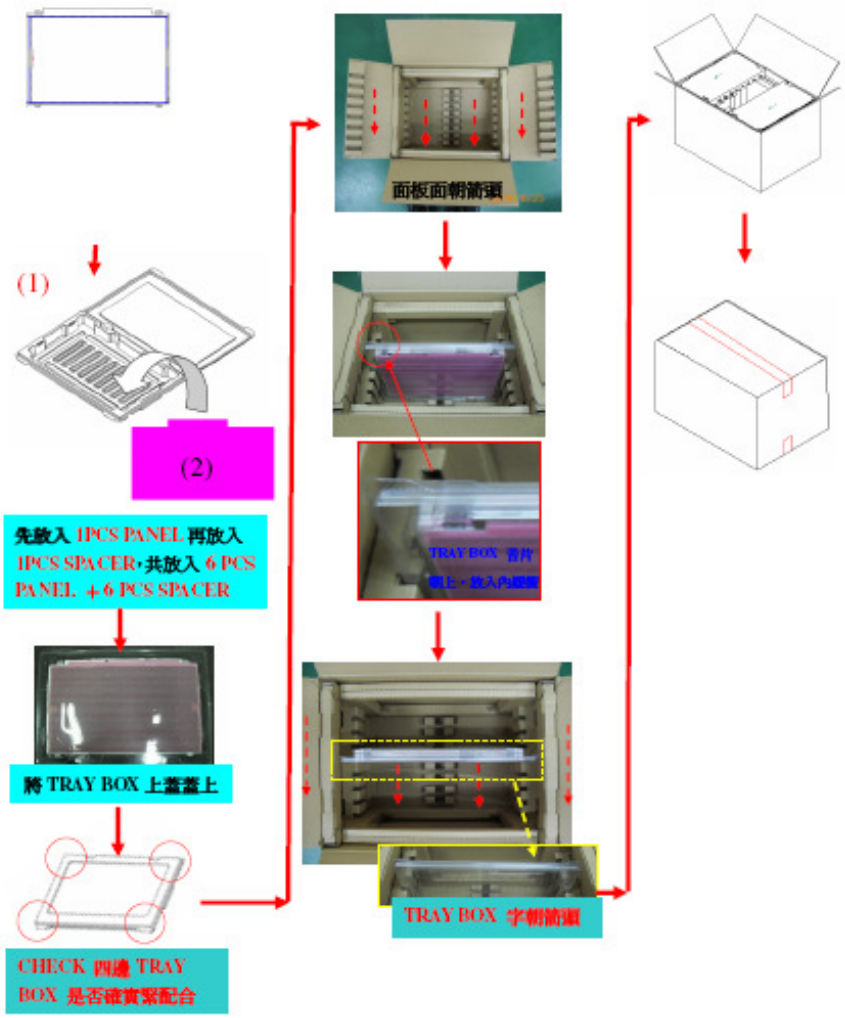
8.1.2 Standard Back View



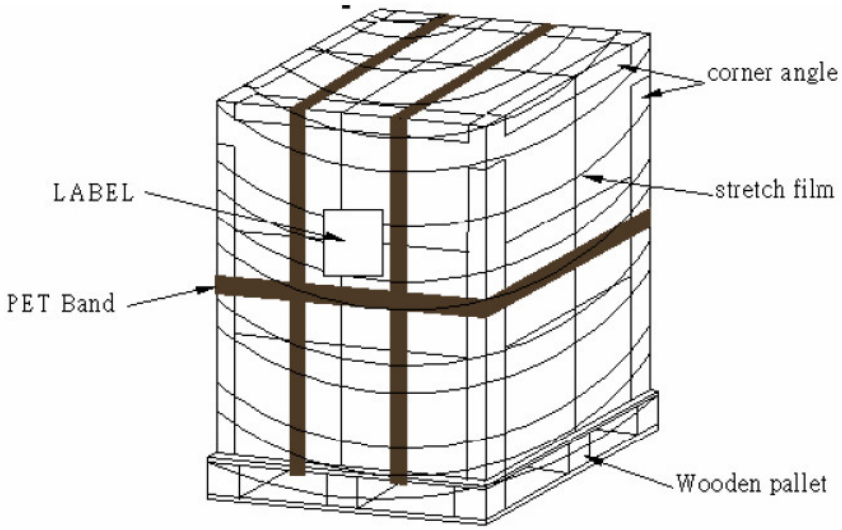
9. Shipping and Package

9.1 Shipping Label Format

9.2 Carton Package



9.3 Shipping Package of Palletizing Sequence



10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	ED	11101101	237	
0B	hex, LSB first	11	00010001	17	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	16	00010110	22	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	**Video input def.** *(digital I/P, non-TMDS, CRGB)*	95	10010101	149	
15	**Max H image size** *(rounded to cm)*	22	00100010	34	
16	**Max V image size** *(rounded to cm)*	13	00010011	19	
17	**Display Gamma** *(=(gamma*100)-100)*	78	01111000	120	
18	**Feature support** *(no DPMS, Active OFF, RGB, tmg Blk#1)*	02	00000010	2	
19	Red/green low bits **(Lower 2:2:2:2 bits)**	06	00000110	6	
1A	Blue/white low bits **(Lower 2:2:2:2 bits)**	95	10010101	149	
1B	Red x **(Upper 8 bits)**	97	10010111	151	
1C	Red y/ highER 8 bits	57	01010111	87	
1D	Green x	53	01010011	83	
1E	Green y	94	10010100	148	
1F	Blue x	26	00100110	38	
20	Blue y	1C	00011100	28	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	00000001	1	
28	Standard timing #2	01	00000001	1	

29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	
2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	14	00010100	20	
37	Pixel Clock/10000 USB	37	00110111	55	
38	Horz active **Lower 8bits**	80	10000000	128	
39	Horz blanking **Lower 8bits**	B8	10111000	184	
3A	HorzAct:HorzBlnk **Upper 4:4 bits**	70	01110000	112	
3B	Vertical Active **Lower 8bits**	38	00111000	56	
3C	Vertical Blanking **Lower 8bits**	24	00100100	36	
3D	Vert Act : Vertical Blanking **(upper 4:4 bit)**	40	01000000	64	
3E	HorzSync. Offset	10	00010000	16	
3F	HorzSync.Width	10	00010000	16	
40	VertSync.Offset : VertSync.Width	3E	00111110	62	
41	Horz&Vert Sync Offset/Width **Upper 2bits**	00	00000000	0	
42	Horizontal Image Size **Lower 8bits**	58	01011000	88	
43	Vertical Image Size **Lower 8bits**	C1	11000001	193	
44	Horizontal & Vertical Image Size **(upper 4:4 bits)**	10	00010000	16	
45	Horizontal Border *(zero for internal LCD)*	00	00000000	0	
46	Vertical Border *(zero for internal LCD)*	00	00000000	0	
47	Signal *(non-intr, norm, no stero, sep sync, neg pol)*	18	00011000	24	
48	Pixel Clock/10,000 (LSB)	B8	10111000	184	
49	Pixel Clock/10,000 (MSB)	24	00100100	36	40Hz frame rate
4A	Horizontal Addressable Pixels, lower 8 bits	80	10000000	128	
4B	Horizontal Blanking Pixels, lower 8 bits	B8	10111000	184	
4C	H Pixels, upper nibble : H Blanking, upper nibble	70	01110000	112	
4D	Vertical Addressable Lines, lower 8 bits	38	00111000	56	
4E	Vertical Blanking Lines, lower 8 bits	24	00100100	36	
4F	V lines, upper nibble : V blanking, upper nibble	40	01000000	64	
50	Horizontal Front Porch, lower 8 bits	10	00010000	16	
51	Horizontal Sync Pulse, lower 8 bits	10	00010000	16	
52	V Front Porch, lower nibble : V Sync Pulse, lower nibble	3E	00111110	62	
53	VFP, 2 bits: VSP 2 bits: HFP 2 bits: HFP 2 bits	00	00000000	0	
54	Horizontal Image Size in mm, lower 8 bits	58	01011000	88	
55	Vertical Image Size in mm, lower 8 bits	C1	11000001	193	
56	H Image Size, upper nibble : V Image Size, upper nibble	10	00010000	16	
57	Horizontal Border	00	00000000	0	

58	Vertical Border	00	00000000	0	
59	Bit Encode Sync Information	18	00011000	24	
5A	DC	00	00000000	0	nVDPS Reserved 00
5B	HTOTAL	00	00000000	0	
5C	HA	00	00000000	0	
5D	HBL	00	00000000	0	
5E	HFP	00	00000000	0	
5F	HFPe	00	00000000	0	
60	HBP	00	00000000	0	
61	HB	00	00000000	0	
62	HSO	00	00000000	0	
63	HS	00	00000000	0	
64	VTOTAL	00	00000000	0	
65	VA	00	00000000	0	
66	VBL	00	00000000	0	
67	VFP	00	00000000	0	
68	VBP	00	00000000	0	
69	VB	00	00000000	0	
6A	VSO	00	00000000	0	
6B	VS	00	00000000	0	
6C	Detail Timing Description #4	00	00000000	0	Header
6D	Flag	00	00000000	0	
6E	Reserved	00	00000000	0	
6F	For Brightness Table and Power Consumption	02	00000010	2	
70	Flag	00	00000000	0	
71	PWM % [7:0] @ Step 0	11	00010001	17	Brightness Table
72	PWM % [7:0] @ Step 5	39	00111001	57	
73	PWM % [7:0] @ Step 10	F9	11111001	249	
74	Nits [7:0] @ Step 0	0A	00001010	10	
75	Nits [7:0] @ Step 5	3C	00111100	60	
76	Nits [7:0] @ Step 10	96	10010110	150	
77	Panel Electronics Power @ 32x32 Chess Pattern =	11	00010001	17	Power Consumption
78	Backlight Power @ 60 nits =	1E	00011110	30	
79	Backlight Power @ Step 10 =	24	00100100	36	
7A	Nits @ 100% PWM Duty =	96	10010110	150	
7B	Flag	20	00100000	32	
7C	Flag	20	00100000	32	
7D	Flag	20	00100000	32	
7E	Extension Flag	00	00000000	0	
7F	Checksum	37	00110111	55	